

ECE 328 – Microcircuit Fabrication

Spring 2025 meeting times: MWF 1:30 to 2:20 pm Prerequisites: EE 327 or instructor consent

This course aims to introduce students to the principles, materials, and methods for the design and fabrication of semiconductor devices, integrated circuits, microelectromechanical systems (MEMS), and microfluidic devices.

General Course Outline / Topics:

- I. Silicon wafer production, microfabrication in cleanrooms
- II. Microfabrication techniques: additive and subtractive processes, lithography
- III. Design and fabrication of semiconductor devices / MEMS
- IV. Introduction to microfluidics
- V. Design and fabrication of microfluidic devices
- VI. Principles of CMOS IC processing

Major Deliverables: (tentative)

Homework ~6 assignments; no late homework is accepted

Microfabrication Exam In class

Project 1 Design and fabrication of an organic LED or organic solar cell

Project 2 Design and fabrication of a microfluidic device

Final Project Design of a CMOS circuit

Curricular Credit:

- Electrophysics Track: this course fulfills a Track Elective course requirement
- Systems & Data Sciences Track: this course fulfills a Technical Elective course requirement
- Computer Engineering: this course fulfills a Technical Elective course requirement

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